

EasyPACK™ module with EDT2 IGBT and Diode and PressFIT / NTC

Features

- Electrical features
 - Blocking voltage 750 V
 - Low V_{CEsat}
 - Low switching losses
 - Low Q_g and C_{rss}
 - Low inductive design
 - $T_{vjop} = 150\text{ °C}$
- Mechanical features
 - 4.2 kV DC 1 second insulation
 - High creepage and clearance distances
 - High power density
 - Integrated NTC temperature sensor
 - PressFIT contact technology
 - RoHS compliant
 - UL 94 V0 module frame



Potential applications

- Automotive applications
- (Hybrid) Electrical Vehicles (H)EV
- Motor drives

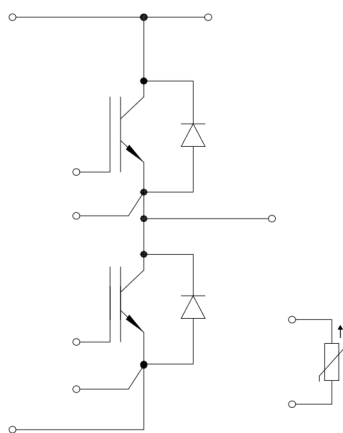
Product validation

- Qualified according to AQC 324

Description

The FF300R08W2P2_B11A is a very compact and flexible product offering integrated isolation for the main inverter of hybrid and electric vehicles. The module uses the benchmark EDT2 IGBT generation allowing 750V blocking voltage and I_{cN} of 300A. The chipset has benchmark current density combined with short circuit ruggedness for reliable inverter operation under harsh environmental conditions. The EDT2 IGBTs also show excellent light load power losses, which helps to improve system efficiency over a real driving cycle. The EDT2 IGBT was optimized for applications with switching frequencies in the range of 10 kHz. The EasyPACK™ package is qualified for automotive applications and is validated according to AQC 324. Its high power cycling capability as well as the high creepage and clearance distances add to the product reliability.

The power module comes with PressFIT Pins for the signal terminals to avoid additional time consuming selective solder processes, which provides cost savings on system level and increases system reliability.



Type	Package	Marking
FF300R08W2P2_B11A	EasyPACK™ 2B Module	SP005424885

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1 Package

1 Package

Table 1 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Maximum RMS module DC-terminal current ¹⁾	I_{tRMS}	$T_{Terminal} = 105\text{ °C}$, $T_C = 65\text{ °C}$	25	A

1) I_{tRMS} : Current per pin, continuous, steady state. Verified by characterization / design not by test

Table 2 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}		4.2	kV
Internal isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Creepage distance	d_{Creep}	terminal to heatsink	11.5	mm
Creepage distance	d_{Creep}	terminal to terminal	6.3	mm
Clearance	d_{Clear}	terminal to heatsink	10.0	mm
Clearance	d_{Clear}	terminal to terminal	5.0	mm
Comparative tracking index	CTI		> 200	

Table 3 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{SCE}			8.0		nH
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T = 25\text{ °C}$, per switch		4.00		mΩ
Storage temperature	T_{stg}		-40		125	°C
Weight	G			41		g

2 IGBT, Inverter

Table 4 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CES}		$T_{vj} = 25\text{ °C}$	750	V
Implemented collector current	I_{CN}			300	A
Continuous DC collector current	$I_{C\ nom}$	$T_{vj\ max} = 150\text{ °C}$	$T_H = 65\text{ °C}$	200	A
Repetitive peak collector current	I_{CRM}	$t_p = 1\text{ ms}$		600	A
Gate-emitter peak voltage	V_{GES}			±20	V

Table 5 **Characteristic values**

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 200\ A, V_{GE} = 15\ V$	$T_{vj} = 25\ ^\circ C$		1.00	1.18	V
			$T_{vj} = 125\ ^\circ C$		0.99		
			$T_{vj} = 150\ ^\circ C$		0.98		
Gate threshold voltage	V_{GEth}	$I_C = 6.4\ mA, V_{CE} = V_{GE}$	$T_{vj} = 25\ ^\circ C$	4.9	5.8	6.5	V
Gate charge	Q_G	$V_{GE} = 15\ V, V_{CE} = 400\ V$			2.9		μC
Internal gate resistor	R_{gint}		$T_{vj} = 25\ ^\circ C$		1.1		Ω
Input capacitance	C_{ies}	$f = 1\ MHz, V_{CE} = 50\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$		53.0		nF
Output capacitance	C_{oes}	$f = 1\ MHz, V_{CE} = 50\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$		0.7		nF
Reverse transfer capacitance	C_{res}	$f = 1\ MHz, V_{CE} = 50\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$		0.20		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 750\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$			1.0	mA
Gate-emitter leakage current	I_{GES}	$V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$			10	nA
Turn-on delay time, inductive load	$t_{d\ on}$	$I_C = 200\ A, V_{CE} = 400\ V, V_{GE} = 15\ V, R_{Gon} = 2.4\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.21		μs
			$T_{vj} = 125\ ^\circ C$		0.23		
			$T_{vj} = 150\ ^\circ C$		0.24		
Rise time, inductive load	t_r	$I_C = 200\ A, V_{CE} = 400\ V, V_{GE} = 15\ V, R_{Gon} = 2.4\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.03		μs
			$T_{vj} = 125\ ^\circ C$		0.04		
			$T_{vj} = 150\ ^\circ C$		0.04		
Turn-off delay time, inductive load	$t_{d\ off}$	$I_C = 200\ A, V_{CE} = 400\ V, V_{GE} = 15\ V, R_{Goff} = 5.1\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.70		μs
			$T_{vj} = 125\ ^\circ C$		0.80		
			$T_{vj} = 150\ ^\circ C$		0.80		
Fall time, inductive load	t_f	$I_C = 200\ A, V_{CE} = 400\ V, V_{GE} = 15\ V, R_{Goff} = 5.1\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.06		μs
			$T_{vj} = 125\ ^\circ C$		0.10		
			$T_{vj} = 150\ ^\circ C$		0.10		
Turn-on energy loss per pulse	E_{on}	$I_C = 200\ A, V_{CE} = 400\ V, L_\sigma = 20\ nH, V_{GE} = 15\ V, R_{Gon} = 2.4\ \Omega$	$T_{vj} = 25\ ^\circ C$		4.4		mJ
			$T_{vj} = 125\ ^\circ C$		7.0		
			$T_{vj} = 150\ ^\circ C, di/dt = 6360\ A/\mu s$		7.6		
Turn-off energy loss per pulse	E_{off}	$I_C = 200\ A, V_{CE} = 400\ V, L_\sigma = 20\ nH, V_{GE} = 15\ V, R_{Goff} = 5.1\ \Omega$	$T_{vj} = 25\ ^\circ C$		7.3		mJ
			$T_{vj} = 125\ ^\circ C$		10.7		
			$T_{vj} = 150\ ^\circ C, du/dt = 2530\ V/\mu s$		11.5		

Table 5 Characteristic values (continued)

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
SC data	I_{SC}	$V_{CC} = 400 \text{ V}$, $V_{GE} = 15 \text{ V}$	$t_P \leq 6.0 \mu\text{s}$, $T_{vj} = 25 \text{ }^\circ\text{C}$	3800		A
			$t_P \leq 4.0 \mu\text{s}$, $T_{vj} = 150 \text{ }^\circ\text{C}$	3000		
Thermal resistance, junction to case	R_{thjc}	per IGBT		0.09		K/W
Thermal resistance, junction to heatsink	R_{thjh}	per IGBT, $\lambda_{\text{paste}} = 3 \text{ W}/(\text{m}^2\text{K})$ / $\lambda_{\text{grease}} = 3 \text{ W}/(\text{m}^2\text{K})$		0.25		K/W
Temperature under switching conditions	$T_{vj \text{ op}}$		-40		150	$^\circ\text{C}$

3 Diode, Inverter

Table 6 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Repetitive peak reverse voltage	V_{RRM}		$T_{vj} = 25\text{ }^{\circ}\text{C}$	750	V
Implemented forward current	I_{Fn}			300	A
Continuous DC forward current	I_F			200	A
Repetitive peak forward current	I_{FRM}	$t_P = 1\text{ ms}$		600	A
I^2t - value	I^2t	$V_R = 400\text{ V}$, $t_P = 50\text{ ms}$	$T_{vj} = 125\text{ }^{\circ}\text{C}$	15770	A^2s
			$T_{vj} = 150\text{ }^{\circ}\text{C}$	13180	

Table 7 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 200 \text{ A}$	$T_{vj} = 25 \text{ }^\circ\text{C}$	1.30	1.47	V
			$T_{vj} = 125 \text{ }^\circ\text{C}$	1.20		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	1.15		
Peak reverse recovery current	I_{rm}	$I_F = 200 \text{ A}$, $V_{CE} = 400 \text{ V}$, $V_{GE} = -8 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$	200		A
			$T_{vj} = 125 \text{ }^\circ\text{C}$	294		
			$T_{vj} = 150 \text{ }^\circ\text{C}$, $-di_F/dt = 7250 \text{ A}/\mu\text{s}$	321		

Table 7 Characteristic values (continued)

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Recovered charge	Q_r	$I_F = 200 \text{ A}$, $V_{CE} = 400 \text{ V}$, $V_{GE} = -8 \text{ V}$	$T_{vj} = 25 \text{ °C}$	11.0		μC
			$T_{vj} = 125 \text{ °C}$	24.0		
			$T_{vj} = 150 \text{ °C}$, $-di_F/dt = 7250 \text{ A}/\mu\text{s}$	29.0		
Reverse recovery energy	E_{rec}	$I_F = 200 \text{ A}$, $V_{CE} = 400 \text{ V}$, $V_{GE} = -8 \text{ V}$, $R_G = 2.4 \Omega$	$T_{vj} = 25 \text{ °C}$	3.34		mJ
			$T_{vj} = 125 \text{ °C}$	7.02		
			$T_{vj} = 150 \text{ °C}$, $-di_F/dt = 7250 \text{ A}/\mu\text{s}$	8.51		
Thermal resistance, junction to case	R_{thjc}	per diode		0.17		K/W
Thermal resistance, junction to heatsink	R_{thjh}	per diode, $\lambda_{paste} = 3 \text{ W}/(\text{m}^2\text{K})$ / $\lambda_{grease} = 3 \text{ W}/(\text{m}^2\text{K})$		0.36		K/W
Temperature under switching conditions	$T_{vj, op}$		-40		150	°C

4 NTC-Thermistor

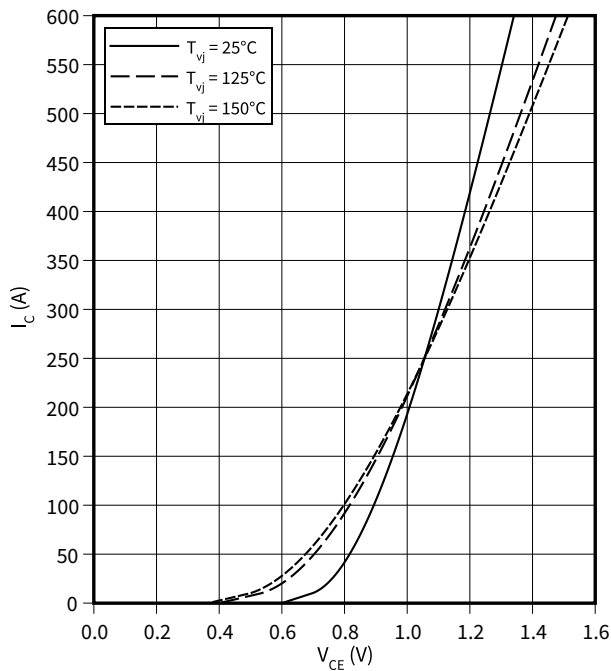
Table 8 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25 \text{ °C}$		5		k Ω
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100 \text{ °C}$, $R_{100} = 493 \Omega$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25 \text{ °C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$		3433		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$		3411		K

5 Characteristics diagrams

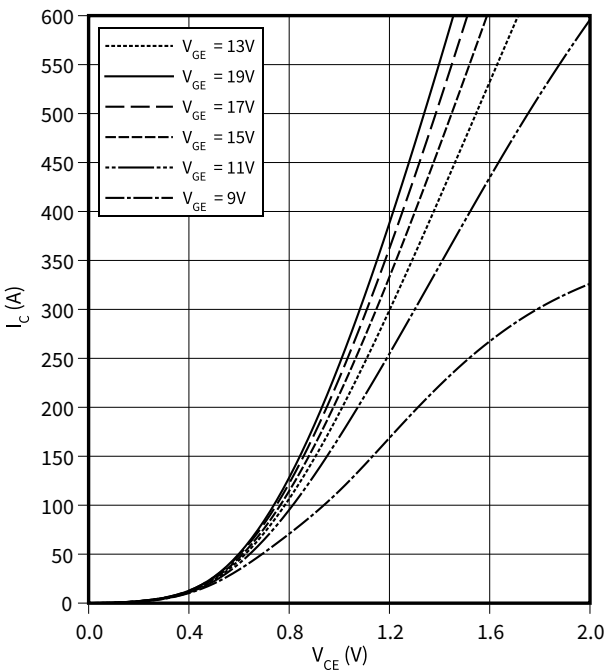
output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$
 $V_{GE} = -8\text{ V} / +15\text{ V}$



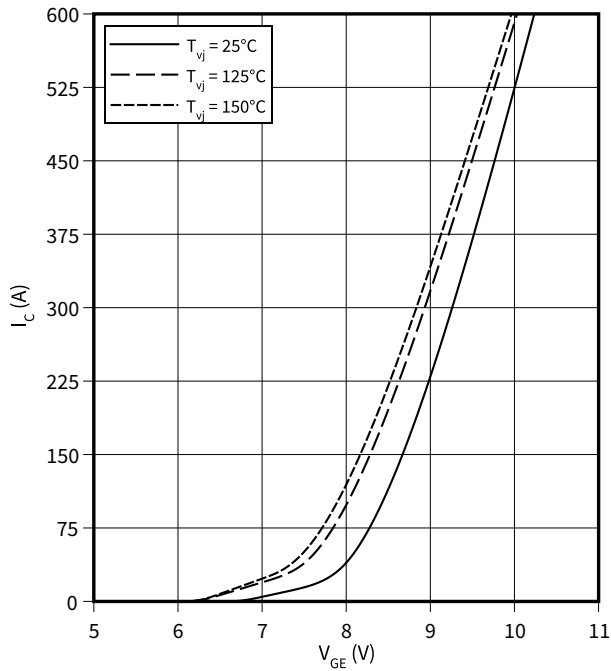
output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$
 $T_{vj} = 25\text{ °C}$



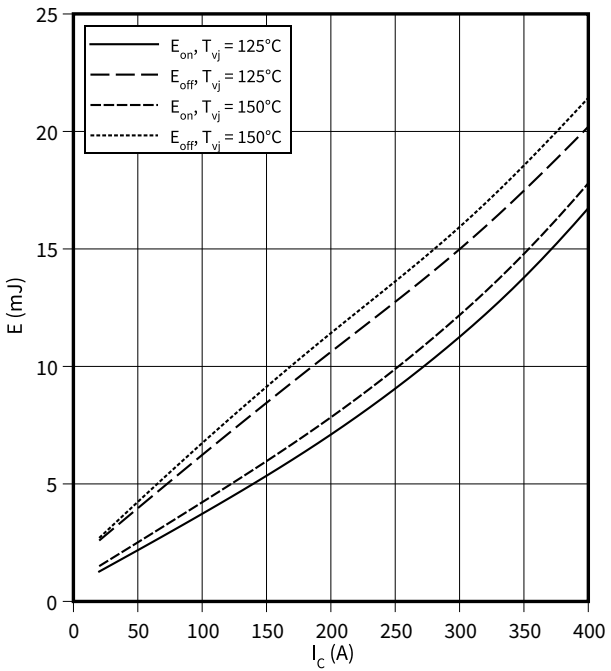
transfer characteristic (typical), IGBT, Inverter

$I_C = f(V_{GE})$
 $V_{CE} = 20\text{ V}$



switching losses (typical), IGBT, Inverter

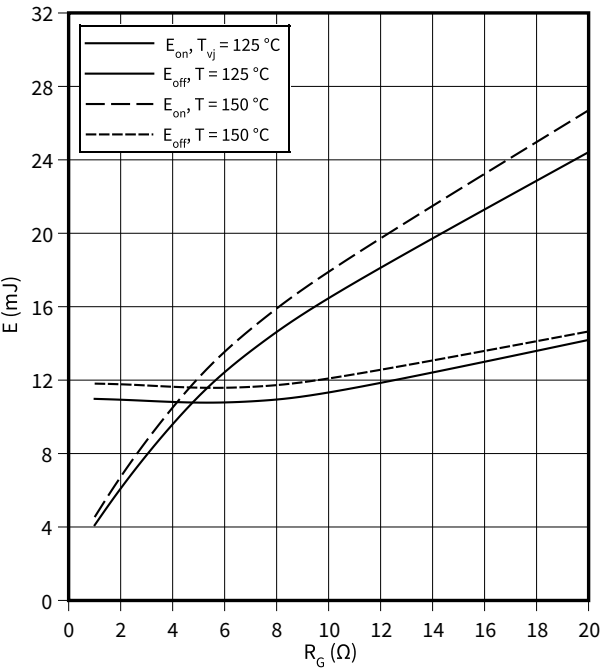
$E = f(I_C)$
 $R_{Goff} = 5.1\text{ }\Omega$, $R_{Gon} = 2.4\text{ }\Omega$, $V_{CE} = 400\text{ V}$, $V_{GE} = -8\text{ V} / +15\text{ V}$



5 Characteristics diagrams

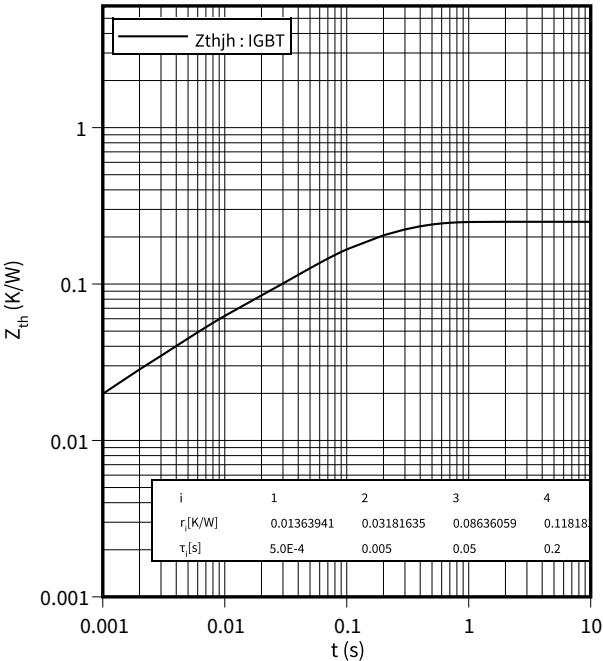
Switching losses (typical), IGBT, Inverter

$E = f(R_G)$
 $V_{CE} = 400\text{ V}$, $V_{GE} = -8\text{ V} / +15\text{ V}$, $I_C = 200\text{ A}$



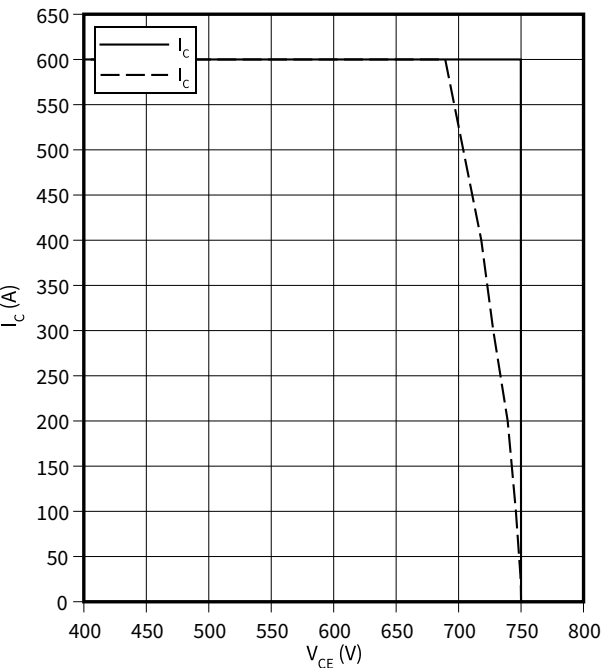
transient thermal impedance , IGBT, Inverter

$Z_{th} = f(t)$



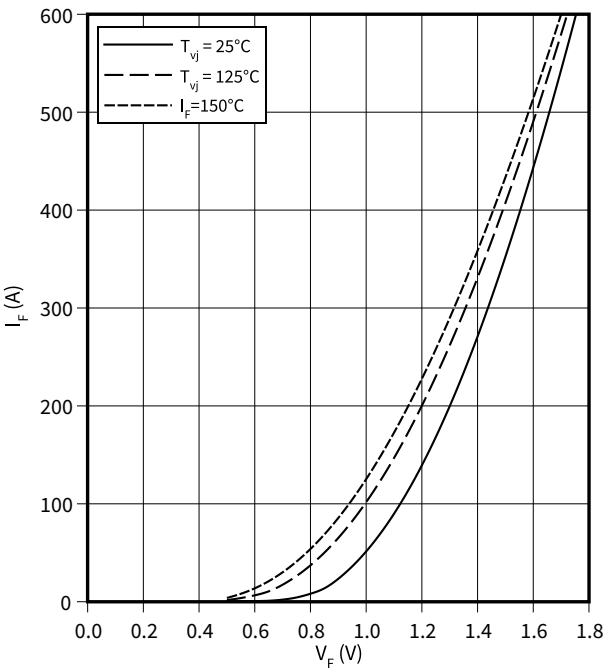
Reverse bias safe operating area (RBSOA), IGBT, Inverter

$I_C = f(V_{CE})$
 $T_{vj} = 150\text{ °C}$, $R_{Goff} = 5.1\text{ Ω}$, $V_{GE} = -8\text{ V} / +15\text{ V}$



forward characteristic of (typical), Diode, Inverter

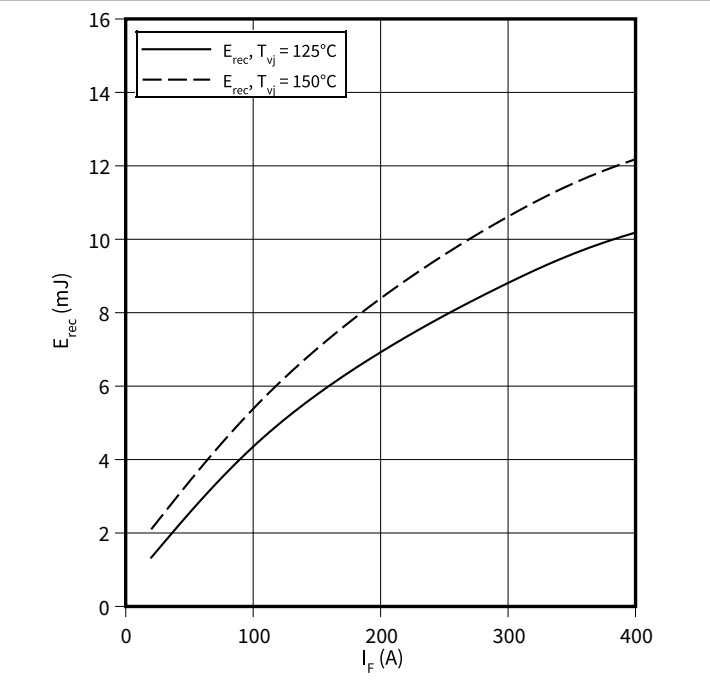
$I_F = f(V_F)$



5 Characteristics diagrams

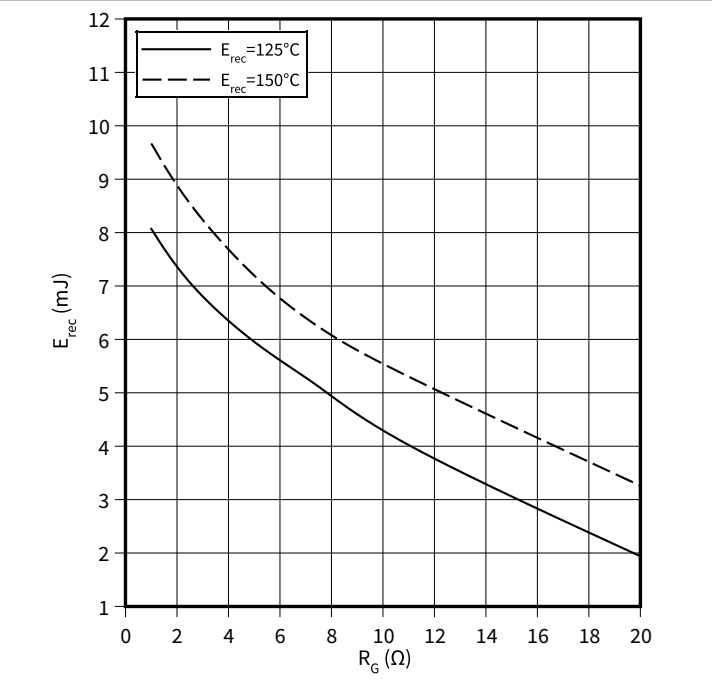
switching losses (typical), Diode, Inverter

$E_{rec} = f(I_F)$
 $R_{Gon} = R_{Gon}(IGBT) , V_{CE} = 400\text{ V}$



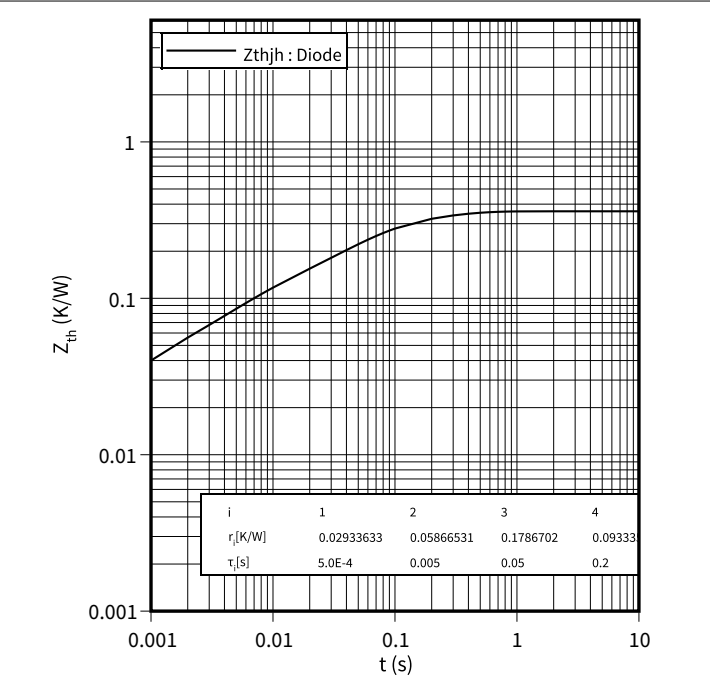
Switching losses (typical), Diode, Inverter

$E_{rec} = f(R_G)$
 $V_{CE} = 400\text{ V}, I_F = 200\text{ A}$



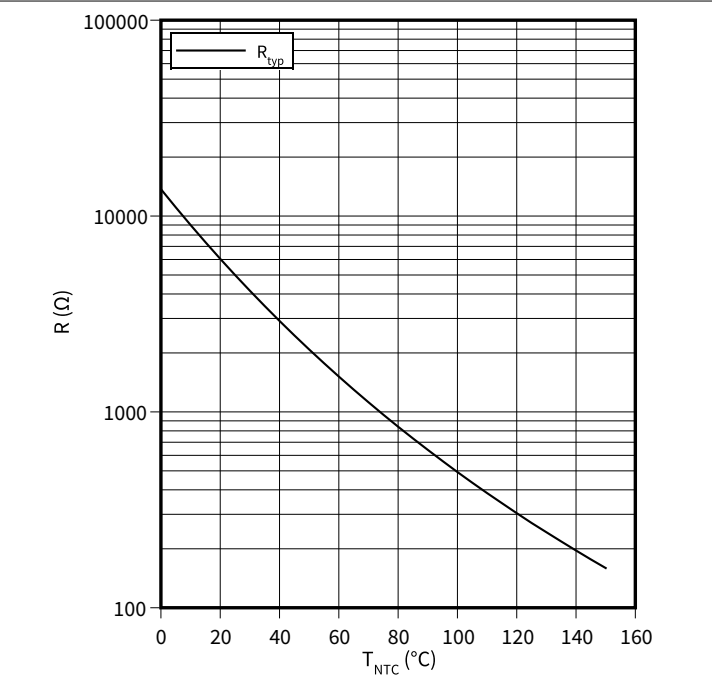
transient thermal impedance , Diode, Inverter

$Z_{th} = f(t)$



temperature characteristic (typical), NTC-Thermistor

$R = f(T_{NTC})$



6 Circuit diagram

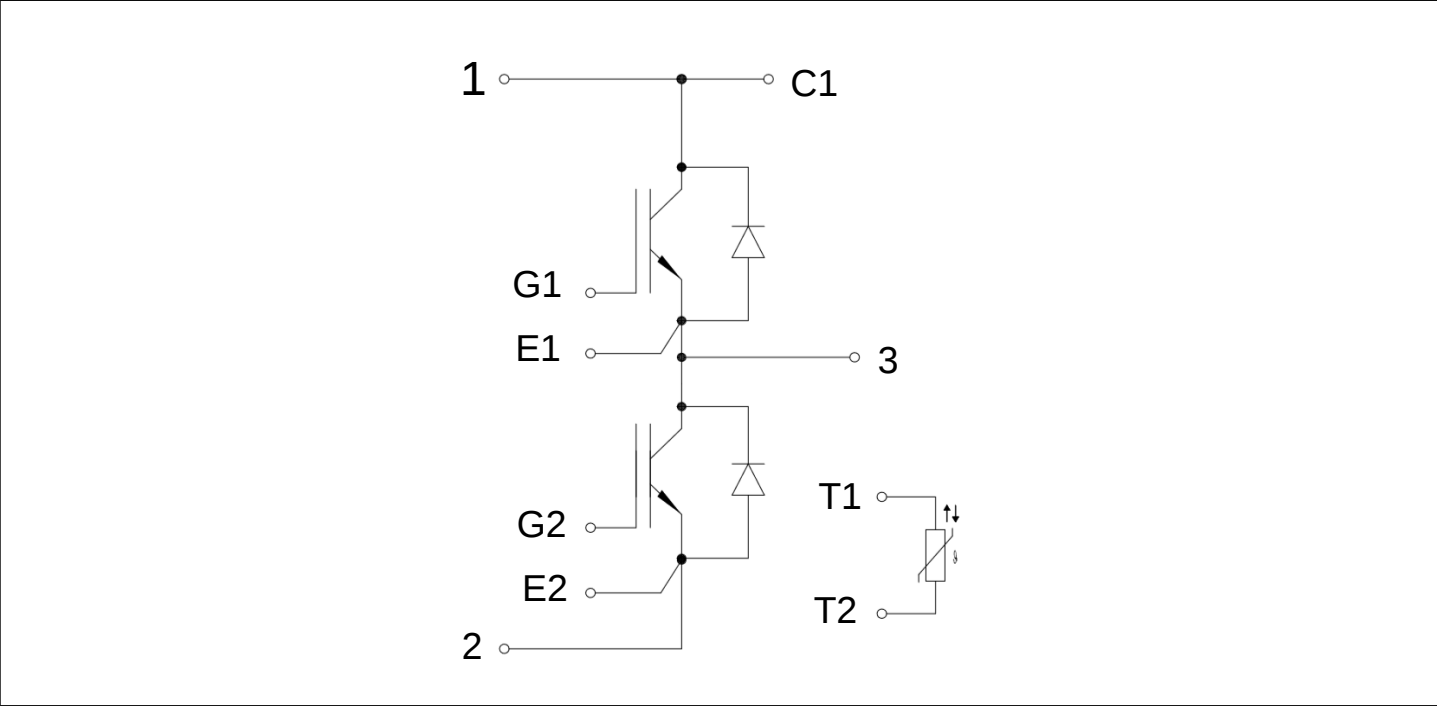


Figure 2



8 Module label code

Module label code			
Code format	Data Matrix		Barcode Code128
Encoding	ASCII text		Code Set A
Symbol size	16x16		23 digits
Standard	IEC24720 and IEC16022		IEC8859-1
Code content	<i>Content</i> Module serial number Module material number Production order number Date code (production year) Date code (production week)	<i>Digit</i> 1 – 5 6 - 11 12 - 19 20 – 21 22 – 23	<i>Example</i> 71549 142846 55054991 15 30
Example	 7154914284655054991153071549142846550549911530		

Packing label code				
Code format	Barcode Code128			
Encoding	Code Set A			
Symbol size	34 digits			
Standard	IEC8859-1			
Code content	<i>Content</i> Module serial number Module material number Production order number Date code (production year) Date code (production week)	<i>Identifier</i> X 1T S 9D Q	<i>Digit</i> 2 – 9 12 – 19 21 – 25 28 – 31 33 – 34	<i>Example</i> 95056609 2X0003E0 754389 1139 15
Example	 X950566091T2X0003E0S754389D1139Q15			

Figure 4

Revision history

Revision history

Document revision	Date of release	Description of changes
V1.0	2020-07-24	Target Datasheet
1.00	2021-07-29	Final datasheet

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Edition 2021-07-29

Published by

Infineon Technologies AG
81726 Munich, Germany

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Document reference
IFX-AAK248-002

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